

- DC input range: 57.6-160V
(Covers 96V and 110V input range)
- Encapsulated circuitry for optimal thermal/vibration performance
- Meet requirements of EN50155
- Size: 61.0mm X 57.9mm X 12.7mm
(2.4" X 2.28" X 0.5")
- Industry standard pinout options
- 5 sided metal shielding for improved EMI performance
- Fixed Frequency operation, simplifies input filter design
- Hiccup output over current protection (OCP)
Latch mode output over voltage protection (OVP)
- Over Temperature Protection (OTP)
- No Minimum Load Required
- Tested to EN61373 for Mechanical Shock and vibration
- Meets EN60068 Damp Heat & Dry Heat requirements
- Extensive reliability qualification, see Page 24 for details
- Reinforced insulation
- 3000Vrms input to output isolation
- UL 60950-1, 2nd Edition
- CAN/CSA-C22.2 No. 60950-1
- EN 60950-1
- RoHS compliant

Optimized for harsh environments in industrial/railway applications, the HBM DC-DC converter series offer regulated outputs in an industry-standard half brick fully encased package.

PRODUCT OVERVIEW

The HBM series delivers the latest technology in fixed frequency power conversion designed for Industrial/railway applications. The HBM series delivers 5V, 12V or 24Vout from an input voltage range of 57.6V – 160V with reinforced I/O galvanic I/O isolation rated at 3,000Vrms. The Half Brick, industry standard packaging offers options for electrical connections & mounting for thermal management in your latest system designs. The HBM series is designed for the highest reliability, incorporating the latest circuit technologies along with proprietary packaging & thermal management techniques to deliver a product that meets critical environmental requirements for Industrial & Railway applications. The modules incorporate many features to protect the power module from fault conditions and also expensive end use equipment. Protection features include input under voltage lockout, output overvoltage protection, output current limit, short circuit (hiccup mode) and over temperature shutdown.

Model Number	Input Voltage (V)	Output Voltage (V)	Iout (A)
110TS5.150HBM	110	5	30
110TS12.150HBM	110	12	12.5
110TS24.150HBM	110	24	6.25

1. Negative Logic ON/OFF feature available. Add "-N" to the part number when ordering.
i.e. 110TS5.150HBM-N

PERFORMANCE SPECIFICATIONS

Model	Vout (V)	IOUT (A) (max)	Total Power (W)	Output				Input				Efficiency	
				Ripple & Noise (mV p-p)		Regulation (Max)		VIN (V) (nom)	Range (V)	IIN, no load (mA)	IIN, full load (A)	Min	Typ
				Typ	Max	Line	Load						
110TS5.150HBM	5	30	150	100	240	±0.2%	±0.3%	110	57.6-160	60	2.92	89.0%	91.0%
110TS12.150HBM	12	12.5	150	100	240	±0.5%	±0.5%	110	57.6-160	60	3	87.0%	89.5%
110TS24.150HBM	24	6.25	150	100	240	±0.2%	±0.3%	110	57.6-160	60	3	88.0%	89.0%

All specifications are at nominal line voltage and full load, +25 °C. Unless otherwise noted. See detailed specifications. Output capacitors are 1 µF ceramic in parallel with 10 µF electrolytic. I/O caps are necessary for our test equipment and may not be needed for your application.

Functional Specifications: All Models

ABSOLUTE MAXIMUM RATINGS	Conditions	Minimum	Typical/Nominal	Maximum	Units
Input Voltage, Continuous		0		160	Vdc
Input Voltage, Transient	100 mS max. duration			170	Vdc
Isolation Voltage(Test voltage)	Input to output			3000	Vrms
	Input to Baseplate			1500	Vrms
	Output to Baseplate			1500	Vrms
On/Off Remote Control	Referred to -Vin	-0.1		15	Vdc
Operating Temperature Range	Ambient Temperature	-40		85	°C
Storage Temperature Range	Baseplate Temperature	-55		125	°C
Absolute Baseplate Temperature				100	°C

Absolute maximums are stress ratings. Exposure of devices to greater than any of these conditions may adversely affect long-term reliability. Proper operation under conditions other than those listed in the Performance/Functional Specifications Table is not implied nor recommended.

INPUT

Operating Input Voltage Range		57.6		160	Vdc
Turn-on Voltage Threshold		52	54.5	57	Vdc
Turn-off Voltage Threshold		50	52	56	Vdc

FEATURES and OPTIONS	Conditions	Minimum	Typical/Nominal	Maximum	Units
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Primary On/Off control (designed to be driving with an open collector logic, Voltages referenced to -Vin)

“Blank” suffix:

Positive Logic, ON state	ON = pin open or external voltage	3.5		15	V
Positive Logic, OFF state	OFF = ground pin or external voltage	0		1	V
Control Current	open collector/drain		1	2	mA

“N” suffix:

Negative Logic, ON state	ON = ground pin or external voltage	-0.1		0.8	V
Negative Logic, OFF state	OFF = pin open or external voltage	2.5		15	V
Control Current	open collector/drain		1	2	mA
Remote Sense Compliance	Sense pins connected externally to respective Vout pins		5		

150 Watt HBM Series DC/DC Converters



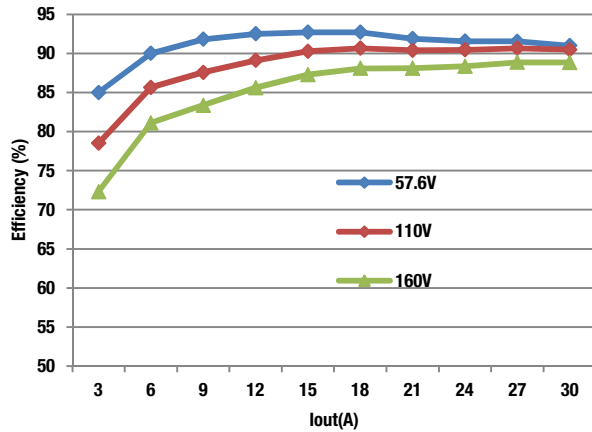
Functional Specifications: All Models

ENVIRONMENTAL					
Operating Ambient Temperature	Ambient Temperature	-40		85	°C
	Baseplate Temperature	-40		100	°C
Storage Temperature		-55		125	°C
Semiconductor Junction Temperature				125	°C
Thermal Protection	Average PCB Temperature		125		°C
Thermal Protection Restart Hysteresis					°C
Electromagnetic Interference	External filter required; see Emissions performance test.		B		Class
Conducted, EN55022/CISPR22					
GENERAL and SAFETY					
Insulation Safety Rating			Reinforced		
Isolation Resistance		10			MΩ
Isolation Capacitance				500	pF
Safety	Certified to UL-60950-1, CSA-22.2 No.60950-1, IEC/EN60950-1, 2nd edition		Yes		
MECHANICAL	Conditions	Minimum	Typical/Nominal	Maximum	Units
Through Hole Pin Diameter			0.08 & 0.04		Inches
			2.032 & 1.016		mm
Through Hole Pin Material			Copper alloy		
TH Pin Plating Metal and Thickness	Nickel subplate		98.4-299		μ-inches
	Gold overplate		4.7-19.6		μ-inches
Outline Dimensions (with baseplate)			2.28x 2.20 x 0.5		Inches
			57.91x55.88 x 12.7		mm
Weight (with baseplate)			3.95		Ounces
			112		Grams

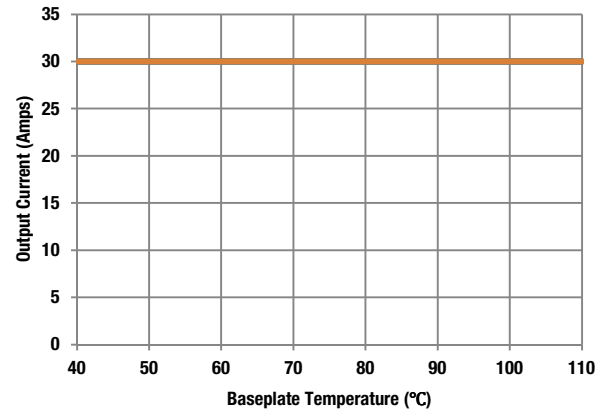
FUNCTIONAL SPECIFICATIONS 110TS5.150HBM					
INPUT	Conditions	Minimum	Typical/Nominal	Maximum	Units
Input current					
Full Load Conditions	Vin = nominal		1.5	1.55	A
Low Line input current	Vin = minimum		2.83	2.92	A
Inrush Transient	Vin = 110V		0.1	0.2	A ² -Sec.
Short Circuit input current			0.05	0.10	A
No Load input current	Iout = minimum, unit=ON		40	60	mA
Shut-Down input current (Off, UV, OT)			7	10	mA
Back Ripple Current	Measured at the input of module with a simulated source impedance of 12μH, 220μF, 450V, across source, 33μF, 250V external capacitors across input pins.			500	mAp-p
Internal Filter Type/Value			Pi		
Recommended Input fuse				10	A
OUTPUT					
Total Output Power		0	150	151.5	W
Voltage					
Setting Accuracy	At 100% load, no trim, all conditions	4.95	5	5.05	Vdc
Output Adjust Range		4.5		5.5	Vdc
Overvoltage Protection	See technical notes for details	6	6.4	7	Vdc
Current					
Output Current Range		0	30	30	A
Minimum Load			0		
Current Limit Inception	cold condition	36	41	45	A
Short Circuit					
Short Circuit Current	Hiccup technique - Auto recovery within 1.25% of Vout		1.4	3	A
Short Circuit Duration (remove short for recovery)	Output shorted to ground, no damage		Continuous		
Short circuit protection method	Hiccup current limiting		Non-latching		
Regulation					
Line Regulation	Vin = 57.6-160, Vout = nom., full load			±0.2	%
Load Regulation	Iout = min. to max., Vin = nom.			±0.3	%
Ripple and Noise	20 MHz BW, Cout = 1μF		60	100	mV pk-pk
	paralleled with 10μF				
Temperature Coefficient	At all outputs		0.02		% of Vnom./°C

FUNCTIONAL SPECIFICATIONS (Continued): 110TS5.150HBM					
Maximum Output Capacitance	(Loads : CR mode)			10,000	μF
	(Loads : CC mode)			10,000	μF
GENERAL and SAFETY					
Efficiency	Vin=110V, full load	89	91		%
Isolation Resistance		10			MΩ
Isolation Capacitance				500	pF
Calculated MTBF	Per Telcordia SR-332, Issue 2, Method 1, Class 1, Ground Fixed, Tcase=+25°C		1300		Hours x 10 ³
DYNAMIC CHARACTERISTICS					
Switching Frequency			200		kHz
Turn On Time					
Rise time	10% Vout to 90% Vout		8	15	mS
Delay time	Vin on to 10% Vout		15	25	mS
Dynamic Load Response	50-75-50%, 1A/us, within 1% of Vout		30	60	μSec
Dynamic Load Peak Deviation	same as above		±120	±240	mV

PERFORMANCE DATA – 110TS5.150HBM



Efficiency vs. Load Current



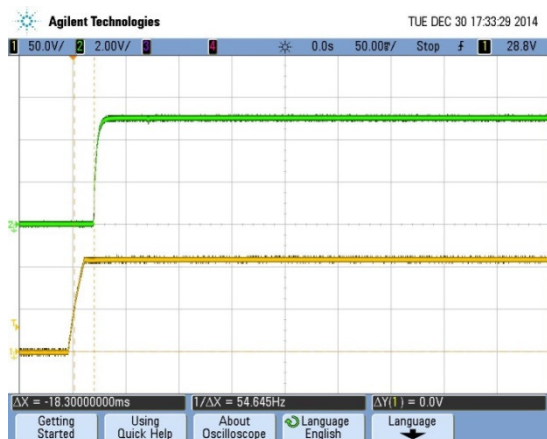
Thermal Derating vs. Baseplate temperature



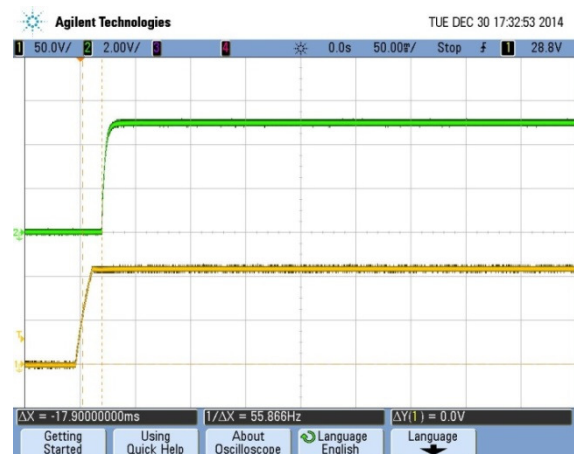
Turn-on transient at zero load current
(5 mS/div, Top Trace: Vout, 2V/div; Bottom Trace: ON/OFF, 2V/div)



Turn-on transient at full load current
(5 mS/div, Top Trace: Vout, 2V/div; Bottom Trace: ON/OFF, 2V/div)

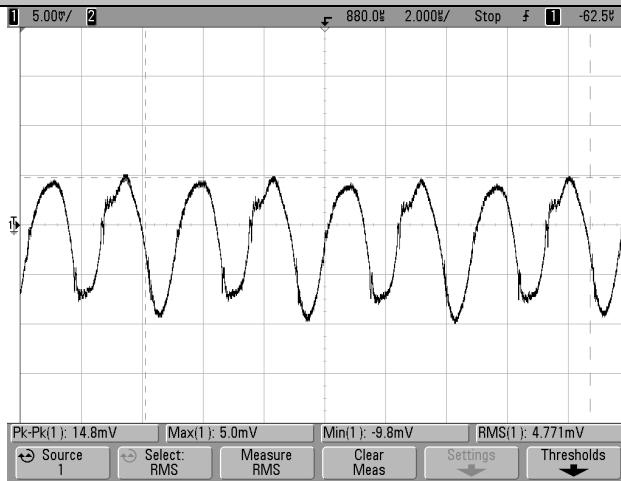


Turn-on transient at zero load current
(50 mS/div, Top Trace: Vout, 2V/div; Bottom Trace: Vin, 50V/div)



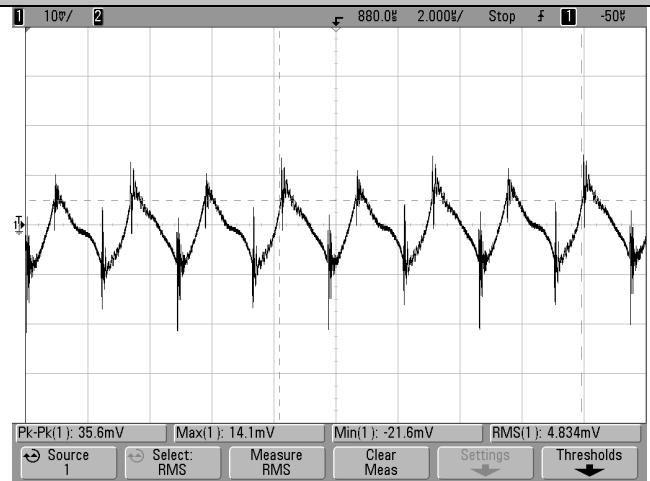
Turn-on transient at full load current
(50 mS/div, Top Trace: Vout, 2V/div; Bottom Trace: Vin, 50V/div)

PERFORMANCE DATA – 110TS5.150HBM



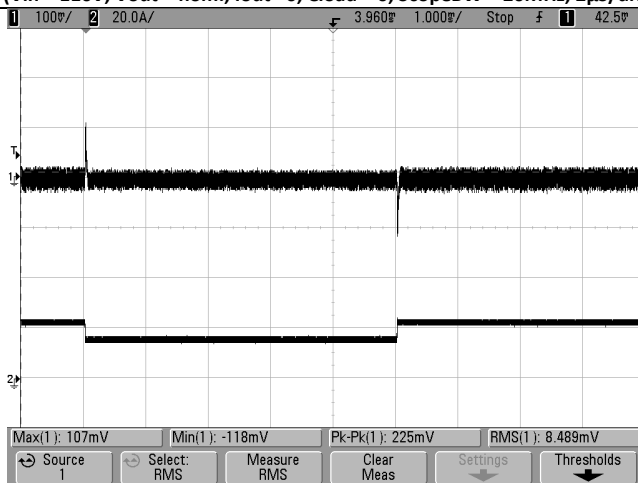
Ripple and Noise @25°C

(Vin = 110V, Vout = nom., Iout = 0, Cloud = 0, ScopeBW = 20MHz, 2μS/div)



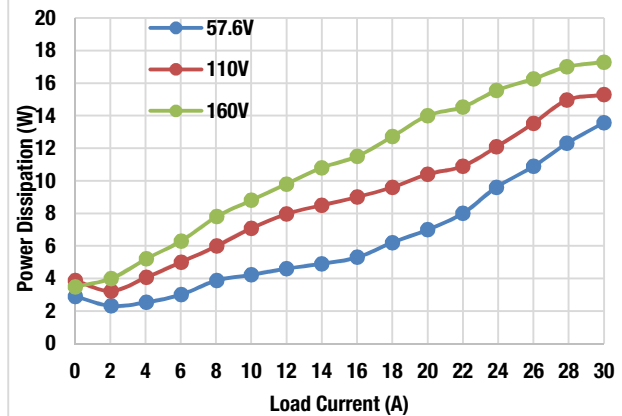
Ripple and Noise @25°C

(Vin = 110V, Vout = nom., Iout = 30A, Cloud = 0, ScopeBW = 20MHz, 2μS/div)

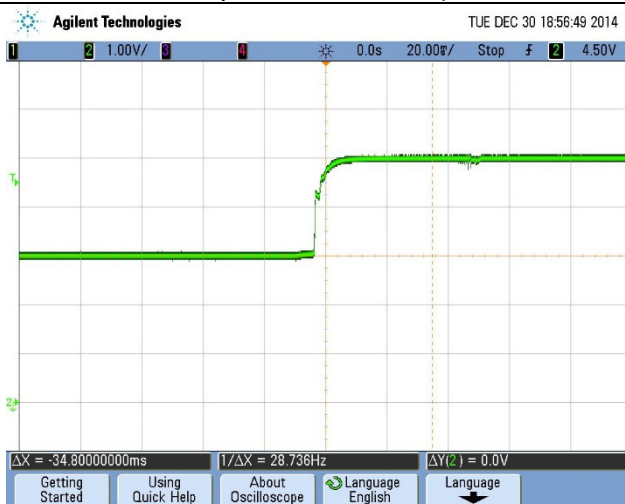


Step Load Transient Response@25°C

(Vin = 110V, Vout = nom., Iout = 50-75-50% of full load, Cloud = 0μF, ScopeBW = 20MHz, 1mS/div)



Power Dissipation vs. Load Current @25°C

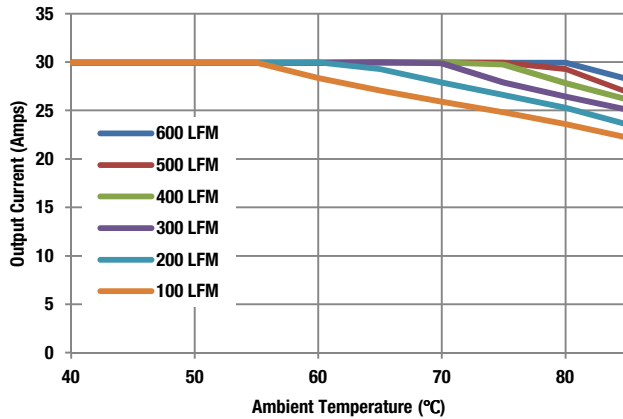


Start-up into a Pre-bias Load@25°C

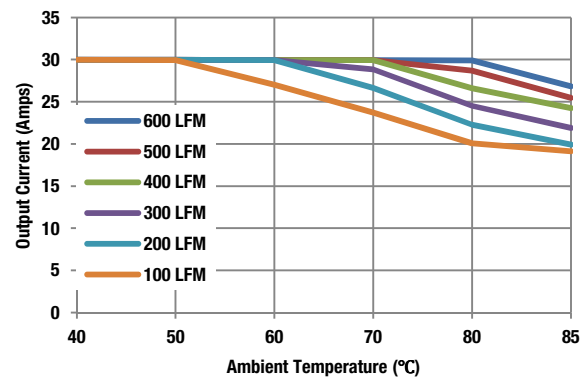
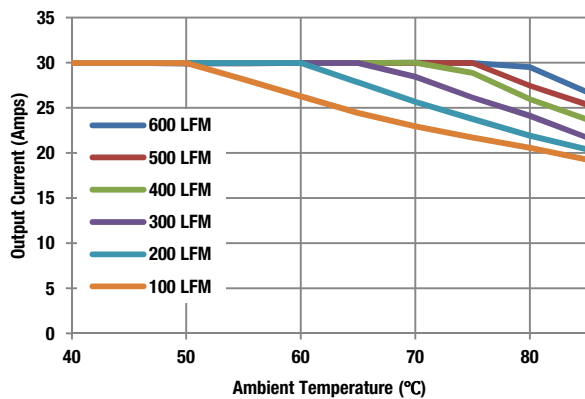
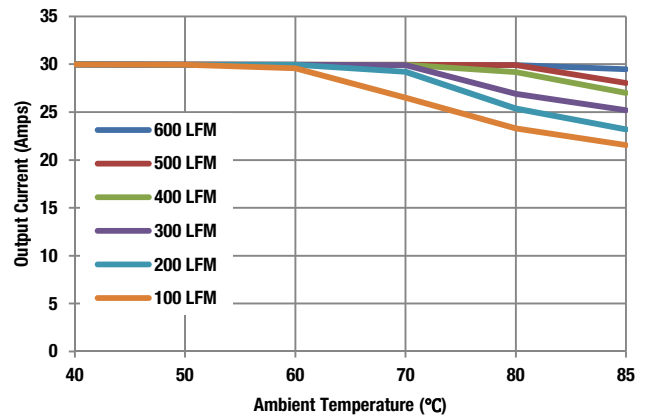
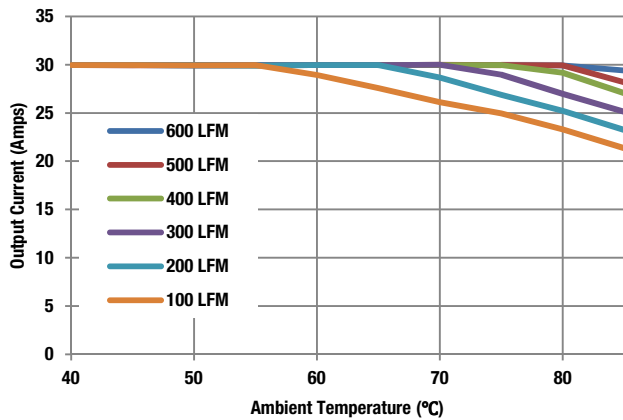
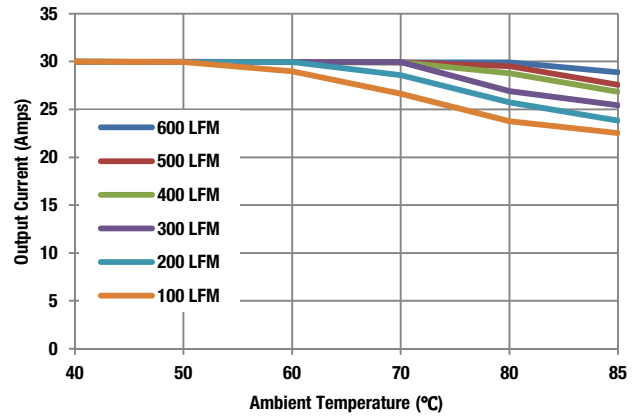
(Vin = 57.6V, Prebias V = 3V, Cloud = 0μF, 20mS/div)

Thermal Derating – 110ST5.150HBM (mounted on a 10 X 10 inch PCB)

TRANSVERSE (AIRFLOW FROM Vin- TO Vin+)



LONGITUDINAL (AIRFLOW FROM Vin TO Vout)

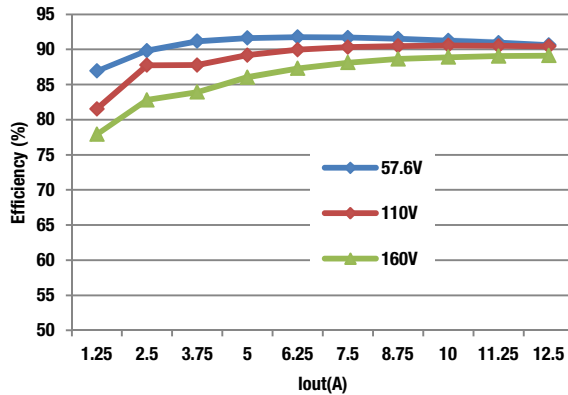


FUNCTIONAL SPECIFICATIONS 110TS12.150HBM					
INPUT	Conditions	Minimum	Typical/Nominal	Maximum	Units
Input current					
Full Load Conditions	Vin = nominal		1.52	1.58	A
Low Line input current	Vin = minimum		2.89	3	A
Inrush Transient	Vin = 110V		0.1	0.2	A ² -Sec.
Short Circuit input current			0.02	0.05	A
No Load input current	Iout = minimum, unit=ON		40	60	mA
Shut-Down input current (Off, UV, OT)			7	60	mA
Back Ripple Current	Measured at the input of module with a simulated source impedance of 12μH, 220μF, 450V, across source, 33μF, 250V external capacitors across input pins.			600	mAp-p
Internal Filter Type/Value			Pi		
Recommended Input fuse				10	A
OUTPUT					
Total Output Power		0	150	151.5	W
Voltage					
Setting Accuracy	At 100% load, no trim, all conditions	11.88	12	12.12	Vdc
Output Adjust Range		10.8		13.2	Vdc
Overvoltage Protection	See technical notes for details	13.8	16	18.75	Vdc
Current					
Output Current Range		0	12.5	12.5	A
Minimum Load			0		
Current Limit Inception	cold condition	14.5	16	18.75	A
Short Circuit					
Short Circuit Current	Hiccup technique - Auto recovery within 1.25% of Vout		1.4	3	A
Short Circuit Duration (remove short for recovery)	Output shorted to ground, no damage		Continuous		
Short circuit protection method	Hiccup current limiting		Non-latching		
Regulation					
Line Regulation	Vin = 57.6-160, Vout = nom., full load			±0.5	%
Load Regulation	Iout = min. to max., Vin = nom.			±0.5	%
Ripple and Noise	20 MHz BW, Cout = 1μF		100	160	mV pk-pk
	paralleled with 10μF				

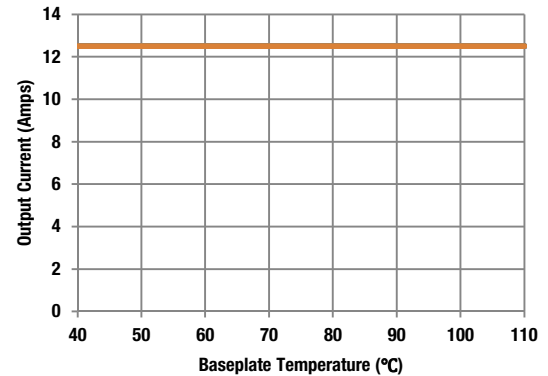
FUNCTIONAL SPECIFICATIONS (Continued): 110TS12.150HBM

Temperature Coefficient	At all outputs		0.02		% of Vnom./°C
Maximum Output Capacitance	(Loads : CR mode)			1000	μF
	(Loads : CC mode)			1000	μF
GENERAL and SAFETY					
Efficiency	Vin=110V, full load	87	89.5		%
Isolation Resistance		10			MΩ
Isolation Capacitance				500	pF
Calculated MTBF	Per Telcordia SR-332, Issue 2, Method 1, Class 1, Ground Fixed, Tcase=+25°C		1300		Hours x 10 ³
DYNAMIC CHARACTERISTICS					
Switching Frequency			200		kHz
Turn On Time					
Rise time	10% Vout to 90% Vout		10	25	mS
Delay time	Vin on to 10% Vout		18	30	mS
Dynamic Load Response	50-75-50%, 1A/us, within 1% of Vout		75	150	μSec
Dynamic Load Peak Deviation	same as above		±250	±400	mV

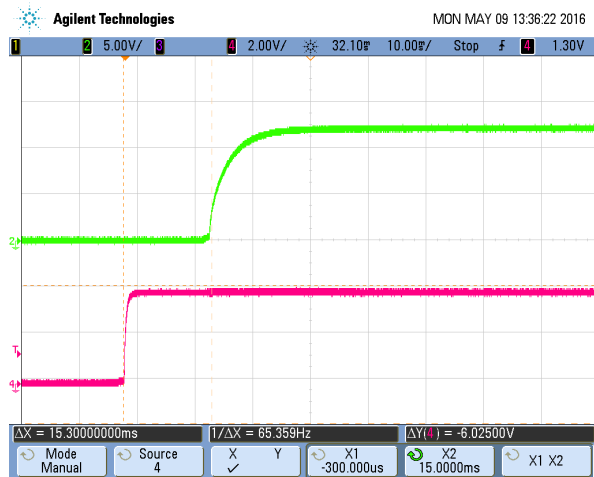
PERFORMANCE DATA – 110TS12.150HBM



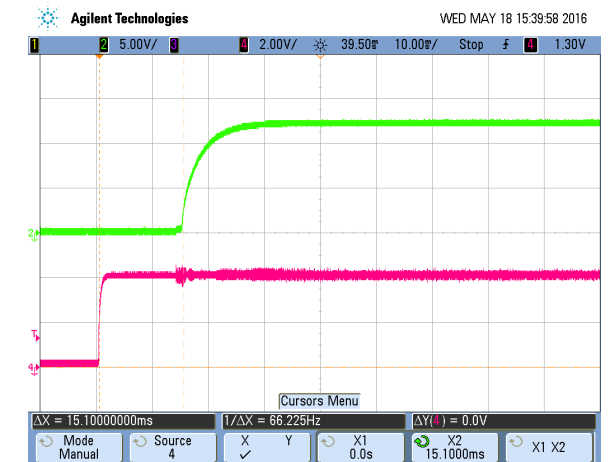
Efficiency vs. Load Current



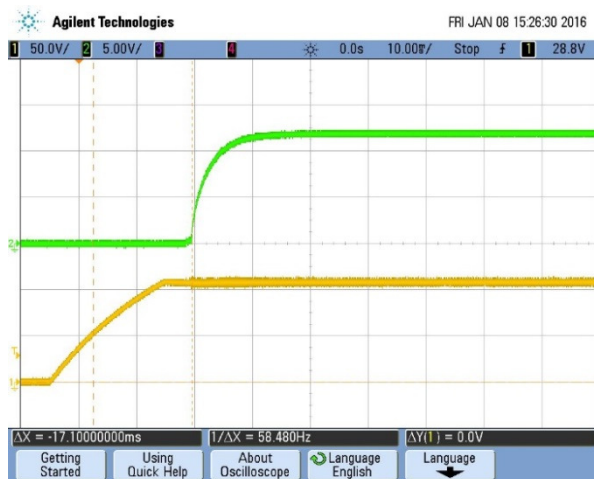
Thermal Derating vs. Baseplate temperature



Turn-on transient at zero load current
(10 ms/div, Top Trace: Vout, 5V/div; Bottom Trace: ON/OFF, 2V/div)



Turn-on transient at full load current
(10 ms/div, Top Trace: Vout, 5V/div; Bottom Trace: ON/OFF, 2V/div)

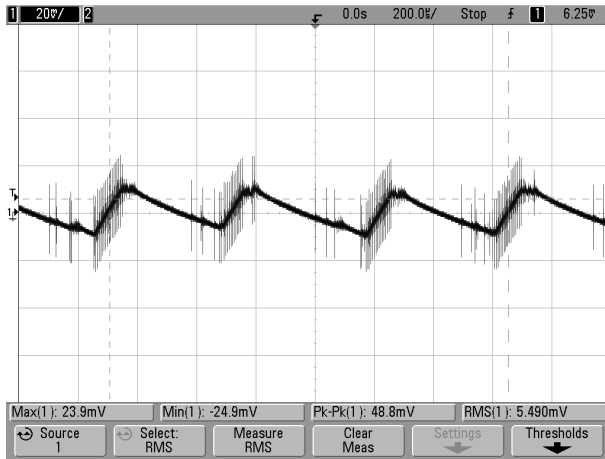


Turn-on transient at zero load current
(10 ms/div, Top Trace: Vout, 5V/div; Bottom Trace: Vin, 50V/div)



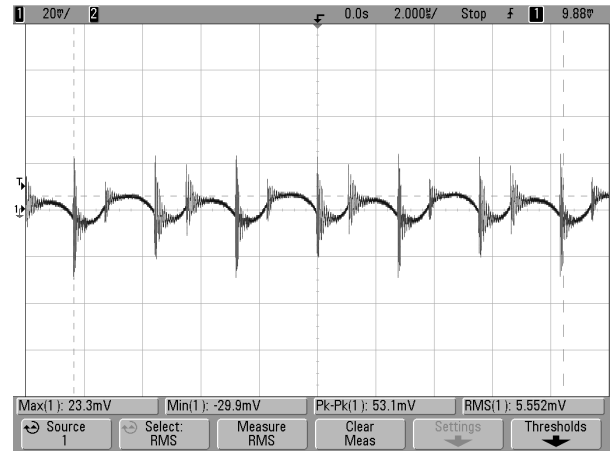
Turn-on transient at full load current
(10 ms/div, Top Trace: Vout, 5V/div; Bottom Trace: Vin, 50V/div)

PERFORMANCE DATA – 110TS12.150HBM



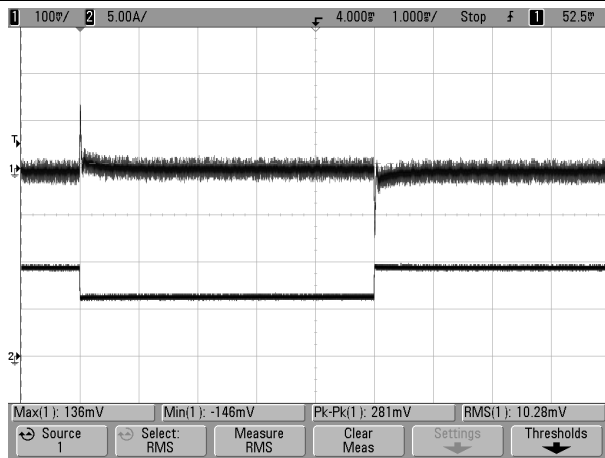
Ripple and Noise @25°C

(Vin = 110V, Vout = nom., Iout = 0, Cload = 0, ScopeBW = 20MHz, 200μS/div)



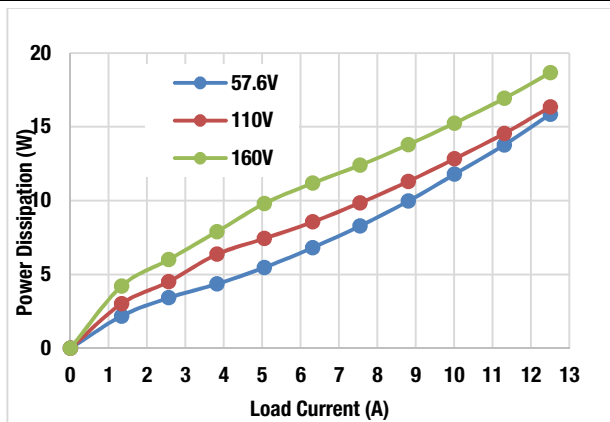
Ripple and Noise @25°C

(Vin = 110V, Vout = nom., Iout = 12.5A, Cload = 0, ScopeBW = 20MHz, 2μS/div)

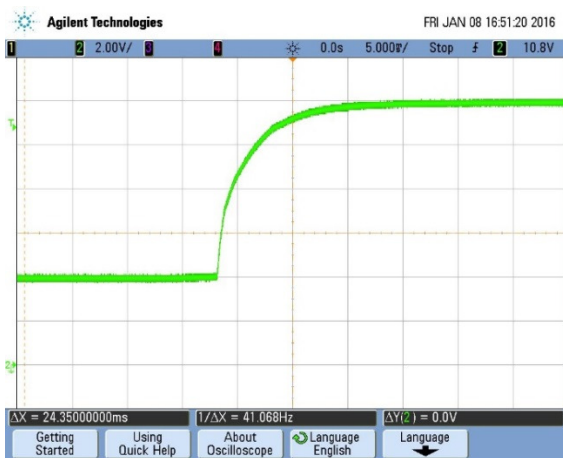


Step Load Transient Response@25°C

(Vin = 110V, Vout = nom., Iout = 50-75-50% of full load, Cload = 0μF, ScopeBW = 20MHz, 1mS/div)



Power Dissipation vs. Load Current @25°C

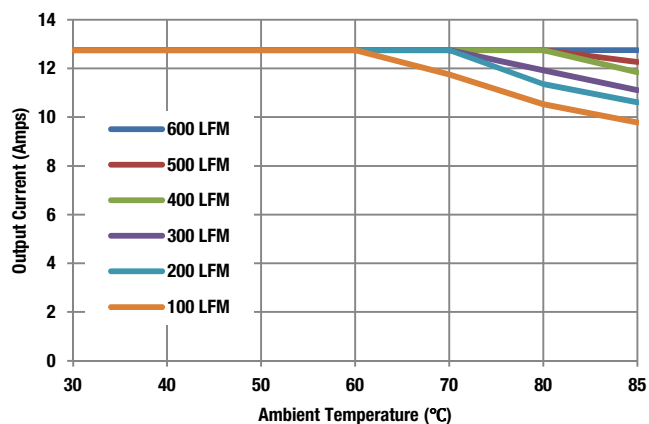


Start-up into a Pre-bias Load@25°C

(Vin = 57.6V, Prebias V = 4V, Cload = 0μF, 5mS/div)

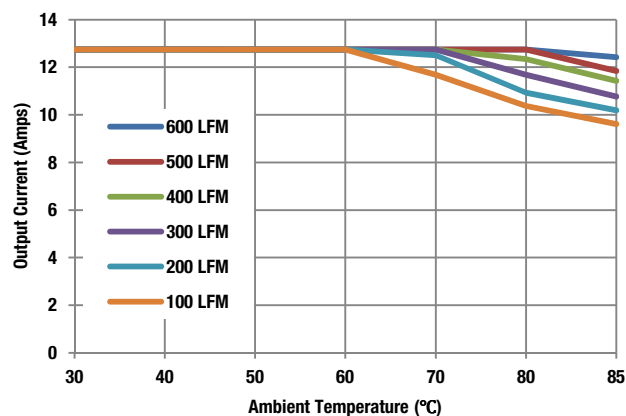
Thermal Derating 110TS12.150HBM (mounted on a 10 X 10 inch PCB)

TRANSVERSE (AIRFLOW FROM Vin- TO Vin+)

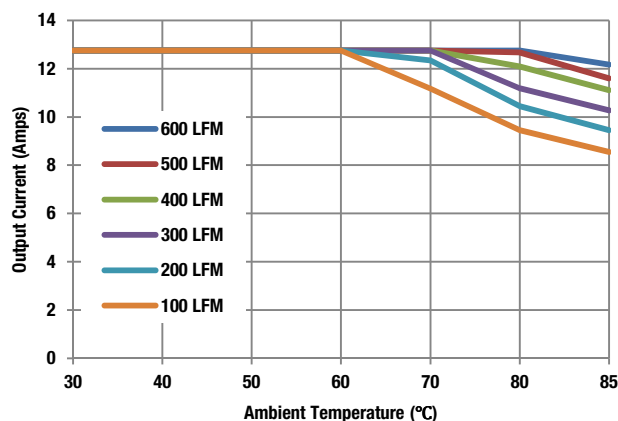


Maximum Current Temperature Derating (Vin = 57.6V)

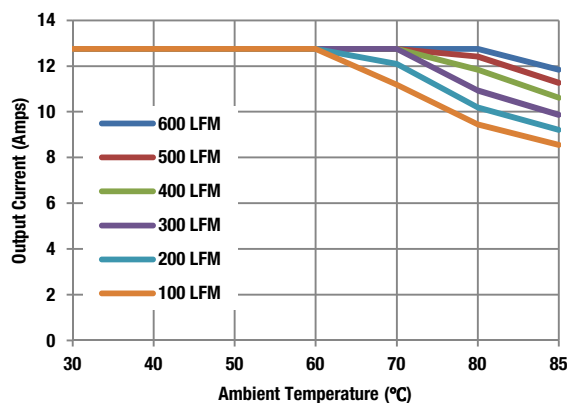
LONGITUDINAL (AIRFLOW FROM Vin TO Vout)



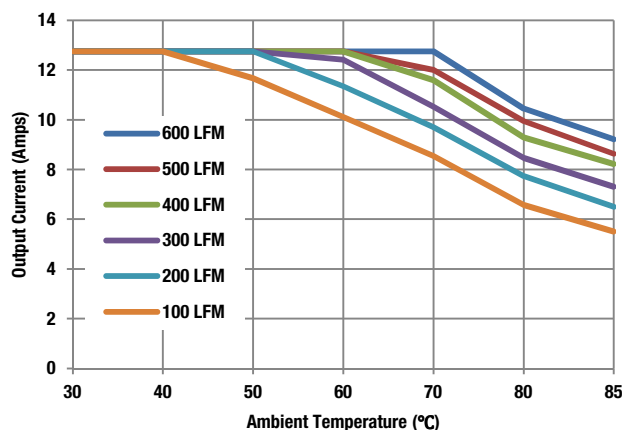
Maximum Current Temperature Derating (Vin = 57.6V)



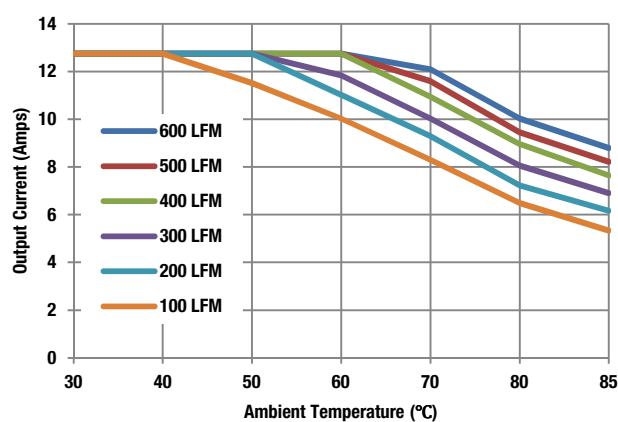
Maximum Current Temperature Derating (Vin = 110V)



Maximum Current Temperature Derating (Vin = 110V)



Maximum Current Derating (Vin = 160V)



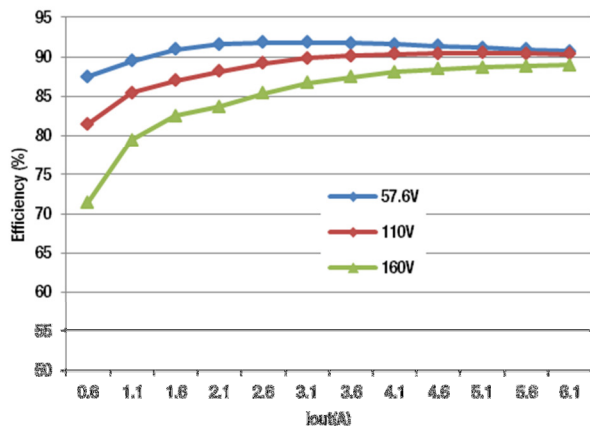
Maximum Current Derating (Vin = 160V)

FUNCTIONAL SPECIFICATIONS: 110TS24.150HBM					
INPUT	Conditions	Minimum	Typical/Nominal	Maximum	Units
Input Current					
Full Load Conditions	Vin = nominal		1.55	1.6	A
Low Line input current	Vin = minimum		2.92	3	A
Inrush Transient	Vin = 110V		0.1	0.2	A ² -Sec.
Short Circuit input current			0.05	0.10	A
No Load input current	Iout = minimum, unit=ON		40	60	mA
Shut-Down input current (Off, UV, OT)			10	30	mA
Back Ripple Current	Measured at the input of module with a simulated source impedance of 12μH, 220μF, 450V, across source, 33μF, 250V external capacitors across input pins.			500	mAp-p
Internal Filter Type/Value			Pi		
Recommended Input fuse				10	A
OUTPUT					
Total Output Power		0	150	151.5	W
Voltage					
Setting Accuracy	At 100% load, no trim, all conditions	23.76	24	24.24	Vdc
Output Adjust Range		21.6		26.4	Vdc
Overvoltage Protection	See technical notes for details	27.5	32	36	Vdc
Current					
Output Current Range		0	6.25	6.25	A
Minimum Load			0		
Current Limit Inception	cold condition	6.93	8.51	9.45	A
Short Circuit					
Short Circuit Current	Hiccup technique - Auto recovery within 1.25% of Vout		1.4	3	A
Short Circuit Duration (remove short for recovery)	Output shorted to ground, no damage		Continuous		
Short circuit protection method	Hiccup current limiting		Non-latching		
Regulation					
Line Regulation	Vin = 57.6-160, Vout = nom., full load			±0.2	%
Load Regulation	Iout = min. to max., Vin = nom.			±0.3	%
Ripple and Noise	20 MHz BW, Cout = 1μF		100	240	mV pk-pk
	paralleled with 10μF				

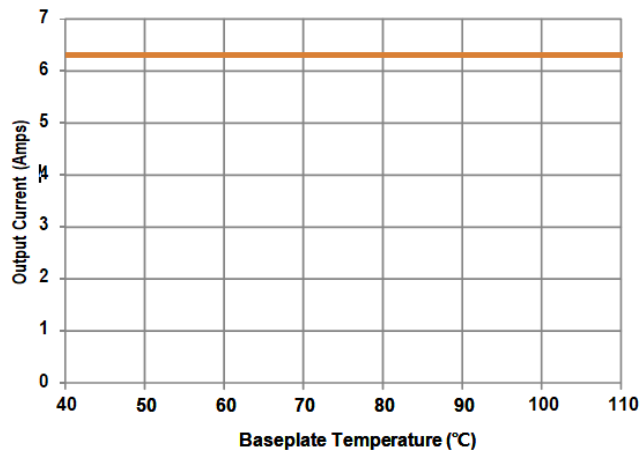
FUNCTIONAL SPECIFICATIONS (Continued): 110TS24.150HBM

Temperature Coefficient	At all outputs		0.02		% of Vnom./°C
Maximum Output Capacitance	(Loads : CR mode)			680	μF
	(Loads : CC mode)			680	μF
GENERAL and SAFETY					
Efficiency	Vin=110V, full load	88	89		%
Isolation Resistance		10			MΩ
Isolation Capacitance				500	pF
Calculated MTBF	Per Telcordia SR-332, Issue 2, Method 1, Class 1, Ground Fixed, Tcase=+25°C		1300		Hours x 10 ³
DYNAMIC CHARACTERISTICS					
Switching Frequency			200		kHz
Turn On Time					
Rise time	10% Vout to 90% Vout		10	30	mS
Delay time	Vin on to 10% Vout		15	30	mS
Dynamic Load Response	50-75-50%, 1A/us, within 1% of Vout			500	μSec
Dynamic Load Peak Deviation	same as above		±400	±600	mV

PERFORMANCE DATA – 110TS24.150HBM



Efficiency vs. Load Current



Thermal Derating vs. Baseplate temperature



Turn-on transient at zero load current
(10 mS/div, Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF, 2V/div)



Turn-on transient at full load current
(10 mS/div, Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF, 2V/div)

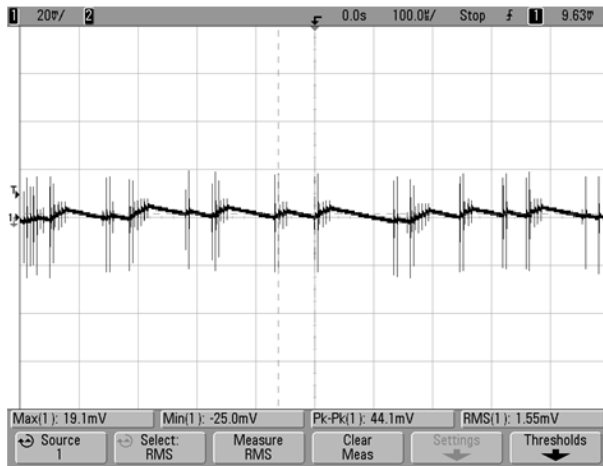


Turn-on transient at zero load current
(50 mS/div, Top Trace: Vout, 10V/div; Bottom Trace: Vin, 50V/div)

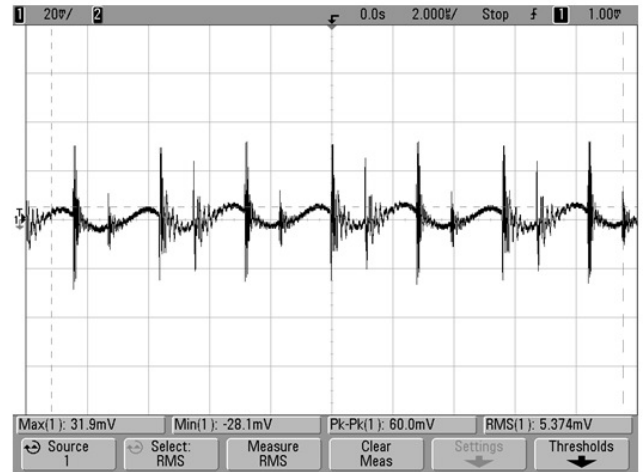


Turn-on transient at full load current
(50 mS/div, Top Trace: Vout, 10V/div; Bottom Trace: Vin, 50V/div)

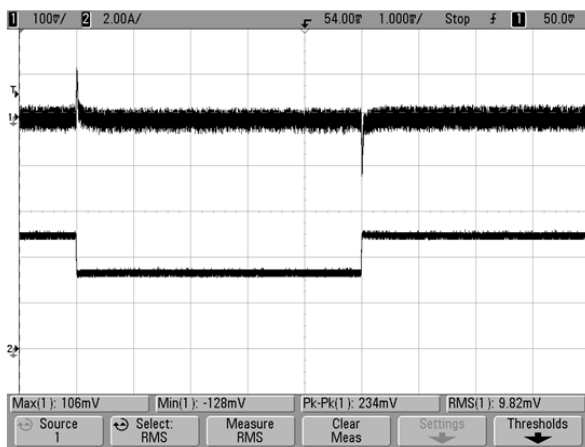
PERFORMANCE DATA – 110TS24.150HBM



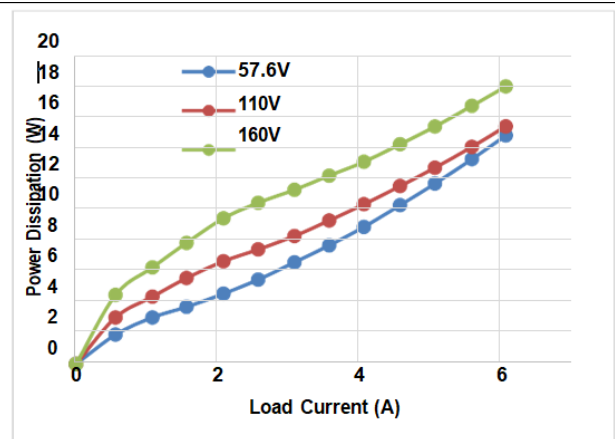
Ripple and Noise @25°C
(Vin=110V, Vout=nom., Iout=0, Cload=0, ScopeBW=20MHz, 100μS/div)



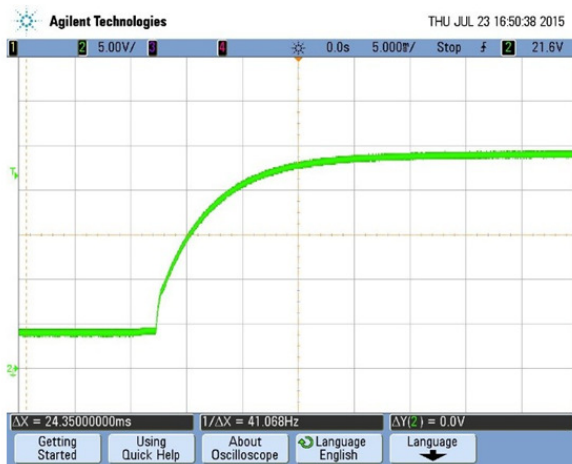
Ripple and Noise @25°C
(Vin = 110V, Vout = nom., Iout= 6.3A, Cload = 0, ScopeBW = 20MHz, 2μS/div)



Step Load Transient Response@25°C
(Vin=110V, Vout=nom., Iout=50-75-50% of fullload, Cload=0μF, ScopeBW =20MHz, 54mS/div)

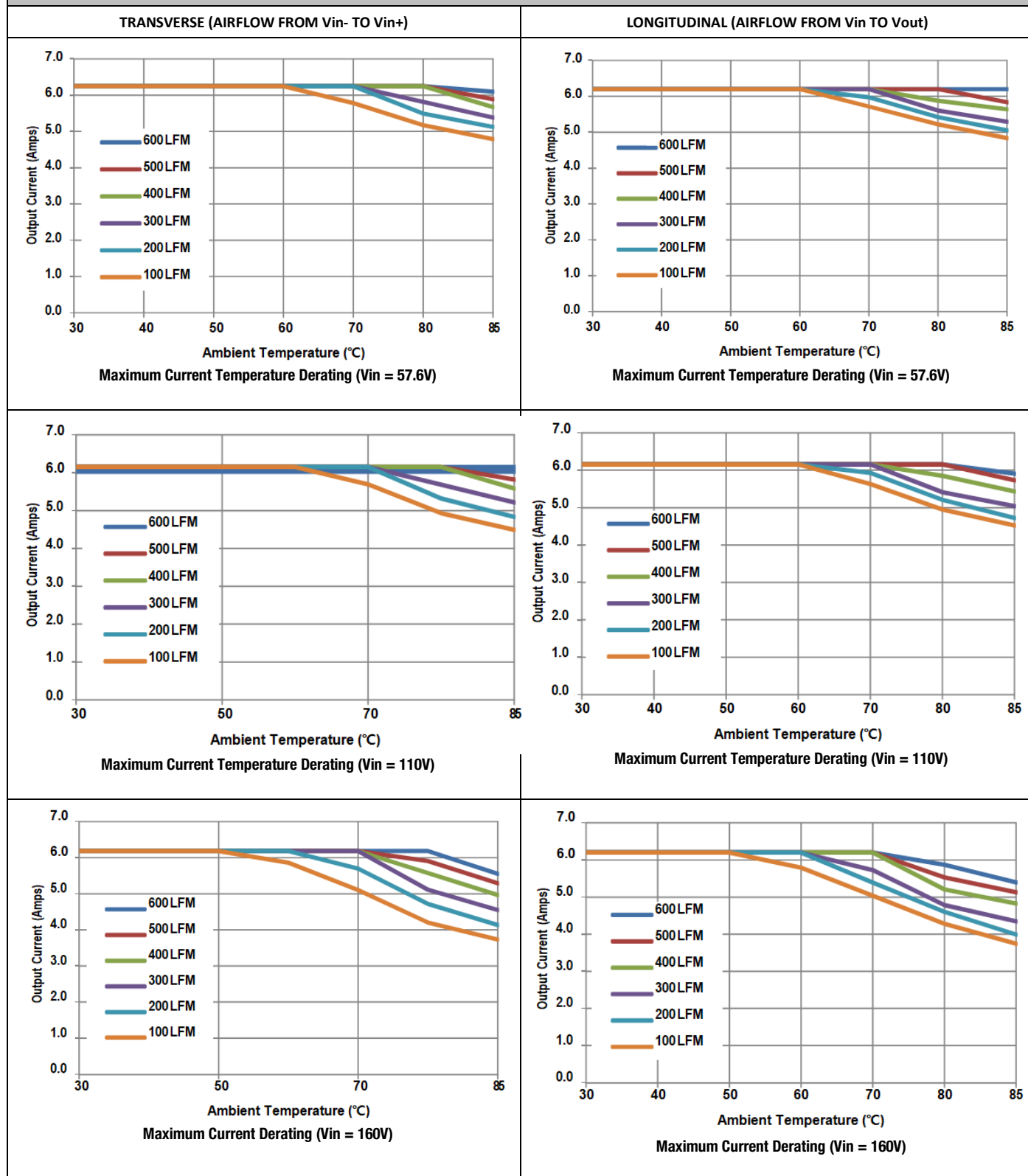


Power Dissipation vs. Load Current @25°C

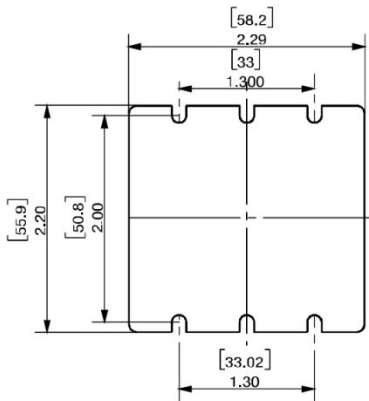


Start-up into a Pre-bias Load@25°C
(Vin=57.6V, Prebias V = 4v, Cload=0μ, 5mS/div)

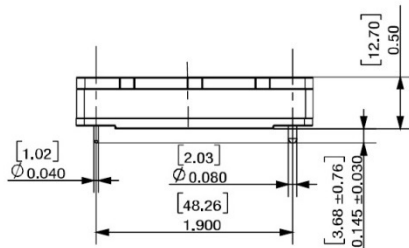
Thermal Derating 110TS24.150HBM (mounted on a 10 X 10 inch PCB)



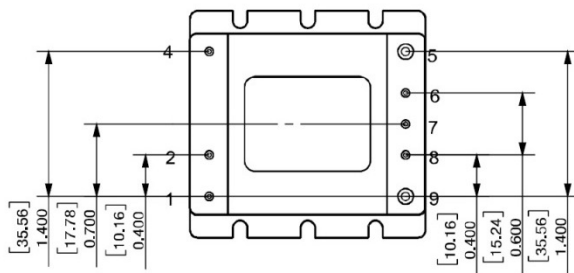
Mechanical Specifications



Top View



Side View



Bottom View

SLOTTED / FLANGED BASEPLATE

MATERIAL:

PINS 1-4, 6-8 DIA. 0.040 PINS: COPPER ALLOY

PINS 5 & 9 DIA 0.080 PINS: COPPER ALLOY

FINISH: (ALL PINS)

GOLD (5μ" MIN) OVER NICKEL (100μ" MIN)

INPUT/OUTPUT CONNECTIONS	
PIN	FUNCTION
1	Vin(+)
2	On/Off Control
4	Vin(-)
5	Vout(-)
6	Sense(-)
7	Trim
8	Sense(+)
9	Vout(+)

NOTES:

UNLESS OTHERWISE SPECIFIED:

1. M3 SCREW USED TO BOLT UNITS BASEPLATE TO OTHER SURFACES (SUCH AS HEATSINKS):

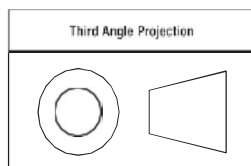
2. FOR STANDARD BASEPLATE, APPLIES TORQUE PER SCREW SHOULD NOT EXCEED 5.3in-lb (0.6Nm)

3. ALL DIMENSIONS ARE IN INCHES (MILLIMETERS):

4. ALL TOLERANCES X.XXin, ±0.02in (X.XXmm, ±0.5mm)

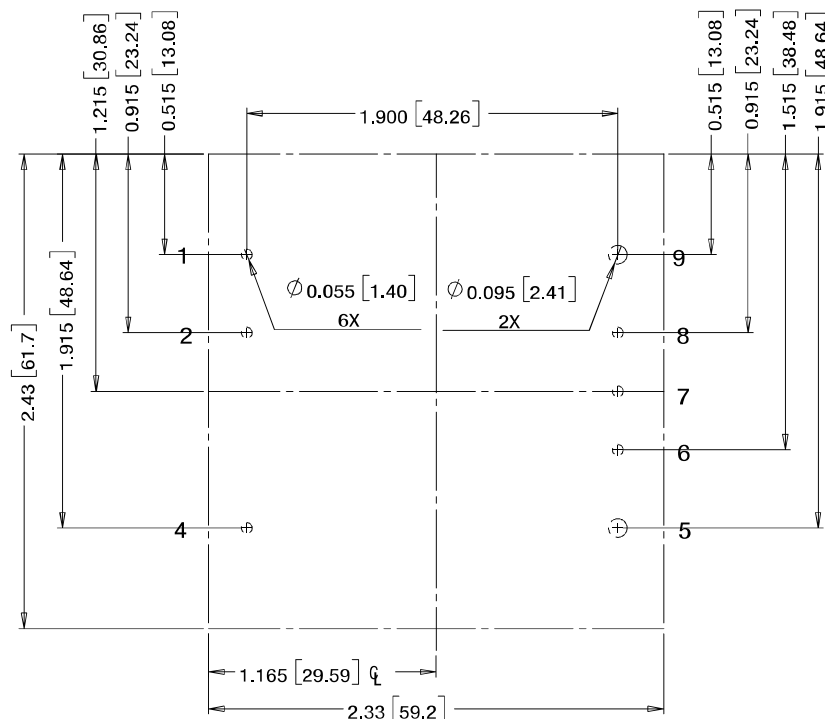
X.XXXin, ±0.01in (X.XXmm, ±0.25mm)

ANGLES ±2°



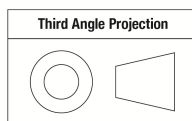
Recommended Footprint

Top View



Recommended Footprint for Slotted / Flanged Baseplate

Dimensions are in inches (mm) shown for ref. only.



Tolerances (unless otherwise specified):

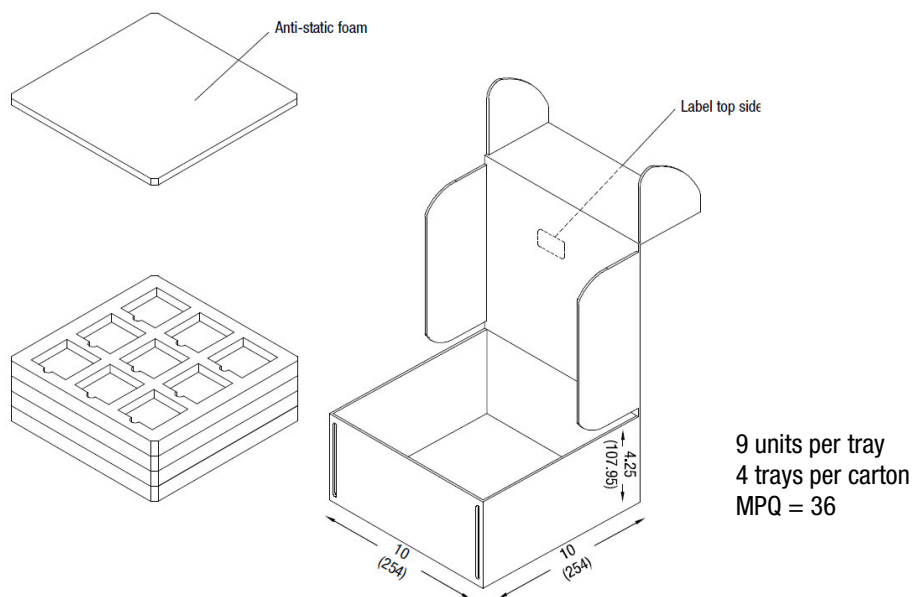
.XX ± 0.02 (0.5)

.XXX ± 0.010 (0.25)

Angles ± 1°

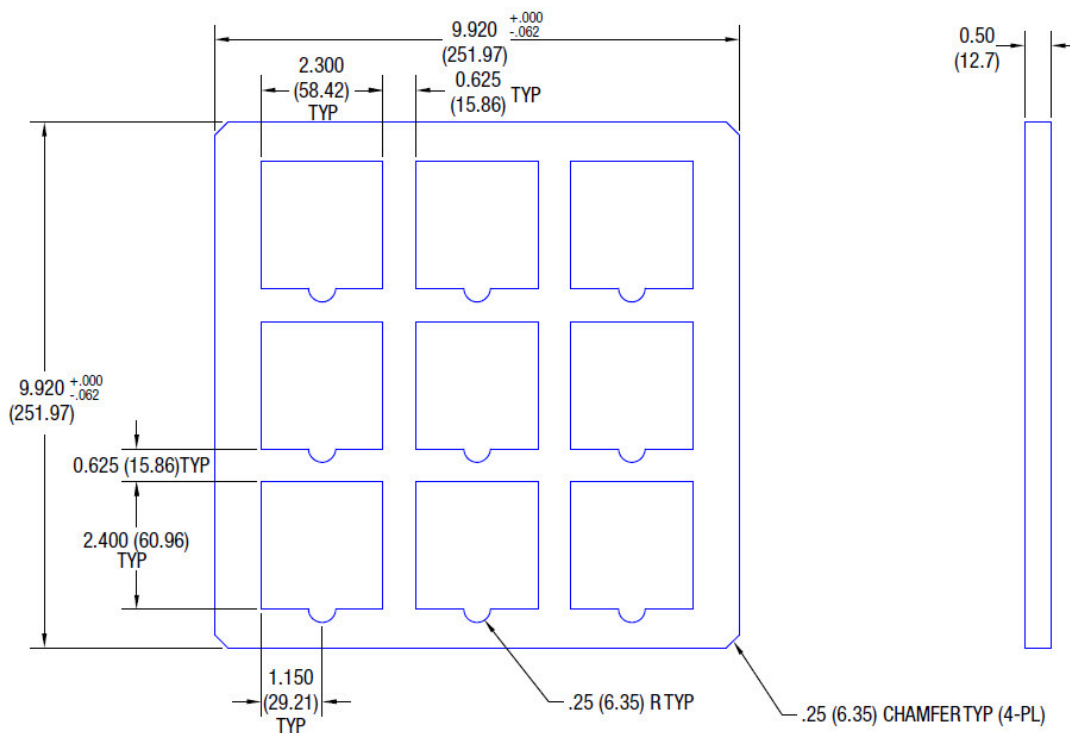
Components are shown for reference only
and may vary between units.

Shipping Trays and Box



Shipping Tray Dimensions

HBM modules are supplied in a 9-piece (3 × 3) shipping tray. The tray is an anti-static closed-cell polyethylene foam. Dimensions are shown below.



STANDARD COMPLIANCE

Parameter	Notes
EN 60950-1/A12:2011	Reinforced insulation
UL 60950-1/R:2011-12	
CAN/CSA-C22.2 No. 60950-1/A1:2011	
IEC 61000-4-2	ESD test, 8 kV - NP, 15 kV air - NP (Normal Performance)
Note: An external input fuse must always be used to meet these safety requirements.	

ENVIRONMENTAL QUALIFICATION TESTING

Parameter	# Units	Test Conditions
Vibration	15	EN 61373:1999 Category I, Class B, Body mounted
Mechanical Shock	15	EN 61373:1999 Category I, Class B, Body mounted
DMTBF(Life Test)	60	Vin nom , units at derating point,101days
Temperature Cycling Test(TCT)	15	-40 °C to 125 °C, unit temp. ramp 15 °C/min.,500cycles
Power and Temperature Cycling Test (PTCT)	5	Temperature operating = min to max, Vin = min to max, Load=50% of rated maximum,100cycles
Temperature ,Humidity and Bias(THB)	15	85 °C85RH, Vin=max, Load=min load,1072Hour(72hours with a pre-conditioning soak, unpowered)
Damp heat test, cyclic	15	EN60068-2-30: Temperatures: + 55 °C and + 25 °C; Number of cycles: 2 (respiration effect);Time: 2 x 24 hours; Relative Humidity: 95%
Dry heat test	5	EN60068-2-2, Vin=nom line, Full load, 85 °C for 6 hours.
High Temperature Operating Bias(HTOB)	15	Vin=min to max ,95% rated load, units at derating point,500hours
Low Temperature operating	5	Vin=nom line, Full load,-40 °C for 2 hours.
Highly Accelerated Life Test(HALT)	5	High temperature limits, low temperature limits, Vibration limits, Combined Environmental Tests.
EMI	3	Class A in CISPR 22 or IEC62236-3-2(GB/T 24338.4)
ESD	3	IEC 6100-4-2: +/-8kv contact discharge +/-15kv air discharge
Surge Protection	3	EN50121-3-2
Solderability	15Pins	MIL-STD-883, method 2003 (IPC/EIA/JEDEC J-SID-002B)

Note: Governing Standard BS EN 50155:2007 Railway applications - Electronics equipment used on rolling stock.

On/Off Control

The input-side, remote On/Off Control function (pin 2) can be ordered to operate with either logic type:

Negative ("N" suffix): Negative-logic devices are off when pin 2 is left open (or pulled high, applying +3.5V to +13V), and on when pin 2 is pulled low (0 to 0.8V) with respect to -Input as shown in Figure 1.

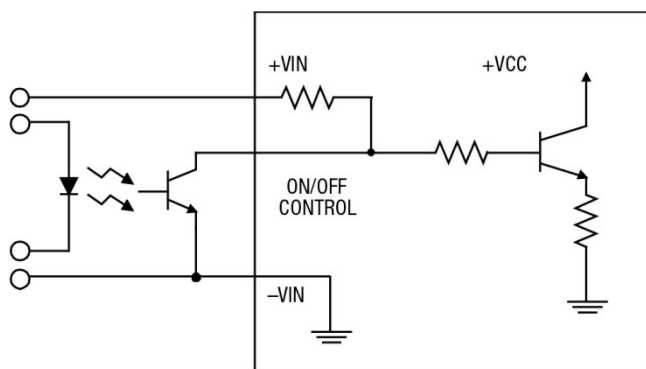


Figure 1. Driving the Negative Logic On/Off Control Pin

Dynamic control of the remote on/off function is best accomplished with a mechanical relay or an open-collector/open-drain drive circuit (optically isolated if appropriate). The drive circuit should be able to sink appropriate current (see Performance Specifications) when activated and withstand appropriate voltage when deactivated. Applying an external voltage to pin 2 when no input power is applied to the converter can cause permanent damage to the converter.

Input Fusing

Certain applications and/or safety agencies may require fuses at the inputs of power conversion components. Fuses should also be used when there is the possibility of sustained input voltage reversal which is not current-limited. For greatest safety, we recommend a fast blow fuse installed in the ungrounded input supply line.

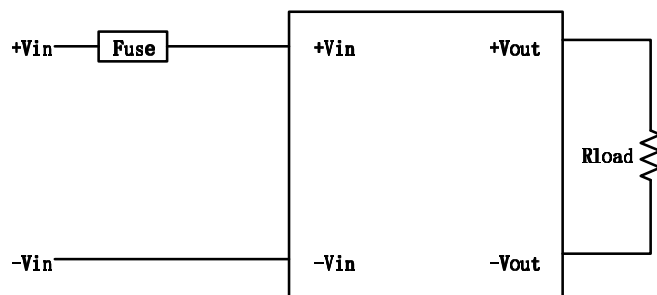


Figure 2. Input Fusing

Input Under-Voltage Shutdown and Start-Up Threshold

Under normal start-up conditions, converters will not begin to regulate properly until the rising input voltage exceeds and remains at the Start-Up Threshold Voltage (see Specifications). Once operating, converters will not turn off until the input voltage drops below the Under-Voltage Shutdown Limit. Subsequent restart will not occur until the input voltage rises again above the Start-Up Threshold. This built-in hysteresis prevents any unstable on/off operation at a single input voltage.

Transient and Surge Protection

The input range of the HBM modules cover EN50155 requirements for Brownout and Transient conditions with Nominal input voltages of 96 & 110Vdc.

EN 50155 standard			
Nominal Input	Permanent input range (0.7 – 1.25 Vin)	Brownout 100mS (0.6 Vin)	Transient 1S (1.4 Vin)
96 V	67.2 – 120 V	57.6 V	134.4 V
110 V	77 – 137.5 V	66 V	154 V

Start-Up Time

Assuming that the output current is set at the rated maximum, the Vin to Vout Start-Up Time (see Specifications) is the time interval between the point when the rising input voltage crosses the Start-Up Threshold and the fully loaded output voltage enters and remains within its specified accuracy band. Actual measured times will vary with input source impedance, external input capacitance, input voltage slew rate and final value of the input voltage as it appears at the converter.

These converters include a soft start circuit to moderate the duty cycle of its PWM controller at power up, thereby limiting the input inrush current.

The On/Off Remote Control interval from On command to Vout (final $\pm 5\%$) assumes that the converter already has its input voltage stabilized above the Start-Up Threshold before the On command. The interval is measured from the On command until the output enters and remains within its specified accuracy band. The specification assumes that the output is fully loaded at maximum rated current. Similar conditions apply to the On to Vout regulated specification such as external load capacitance and soft start circuitry.

Recommended Input Filtering

The user must assure that the input source has low AC impedance to provide dynamic stability and that the input supply has little or no inductive content, including long distributed wiring to a remote power supply. The converter will operate with no additional external capacitance if these conditions are met.

For best performance, we recommend installing a low-ESR capacitor immediately adjacent to the converter's input terminals. The capacitor should be a ceramic type such as the Murata GRM32 series or a polymer type. Make sure that the input terminals do not go below the undervoltage shutdown voltage at all times. More input bulk capacitance may be added in parallel (either electrolytic or tantalum) if needed.

Recommended Output Filtering

The converter will achieve its rated output ripple and noise with no additional external capacitor. However, the user may install more external output capacitance to reduce the ripple even further or for improved dynamic response. Again, use low-ESR ceramic (Murata GRM32 series) or polymer capacitors. Mount these close to the converter. Measure the output ripple under your load conditions.

Use only as much capacitance as required to achieve your ripple and noise objectives. Excessive capacitance can make step load recovery sluggish or possibly introduce instability. Do not exceed the maximum rated output capacitance listed in the specifications.

Input Ripple Current and Output Noise

All models in this converter series are tested and specified for input reflected ripple current and output noise using designated external input/output components, circuits and layout as shown in the figures below. The Cbus and Lbus components simulate a typical DC voltage bus.

Output Over-Voltage Protection

The HBM output voltage is monitored for an over-voltage condition using a comparator. The signal is optically coupled to the primary side and if the output voltage rises to a level which could be damaging to the load, the sensing circuitry will disable the PWM controller drive causing the output voltage to decrease. It is referred to as "latch" mode.

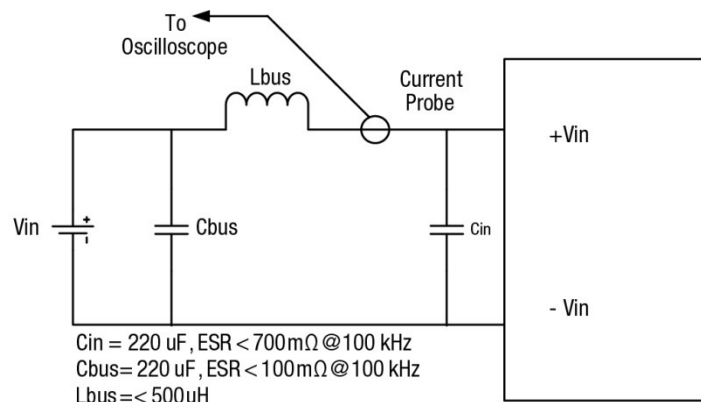


Figure 3. Measuring Input Ripple Current

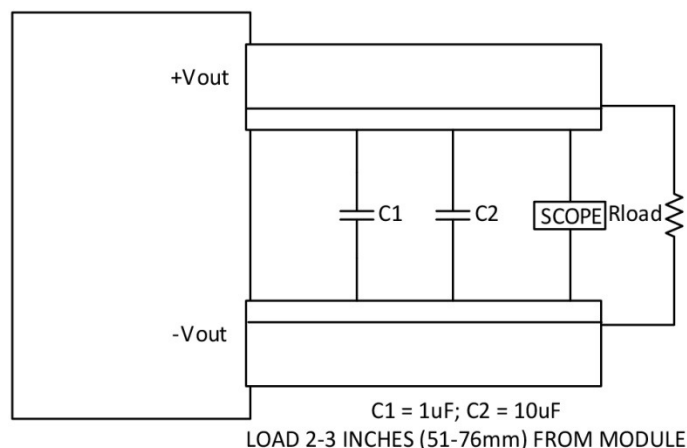


Figure 4. Measuring Output Ripple and Noise (PARD)

Minimum Output Loading Requirements

All models regulate within specification and are stable under no load to full load conditions. Operation under no load might however slightly increase output ripple and noise.

Thermal Shutdown

To prevent many over temperature problems and damage, these converters include thermal shutdown circuitry. If environmental conditions cause the temperature of the DC-DC's to rise above the Operating Temperature Range up to the shutdown temperature, an on-board electronic temperature sensor will power down the unit. When the temperature decreases below the turn-on threshold, the converter will automatically restart. There is a small amount of hysteresis to prevent rapid on/off cycling.

CAUTION: If you operate too close to the thermal limits, the converter may shut down suddenly without warning. Be sure to thoroughly test your application to avoid unplanned thermal shutdown.

Temperature Derating Curves

The graphs in this data sheet illustrate typical operation under a variety of conditions. The Derating curves show the maximum continuous ambient air temperature and decreasing maximum output current which is acceptable under increasing forced airflow measured in Linear Feet per Minute ("LFM"). Note that these are AVERAGE measurements. The converter will accept brief increases in current or reduced airflow as long as the average is not exceeded.

Note that the temperatures are of the ambient airflow, not the converter itself which is obviously running at higher temperature than the outside air.

CAUTION: If you exceed these Derating guidelines, the converter may have an unplanned Over Temperature shut down. Also, these graphs are all collected near Sea Level altitude. Be sure to reduce the derating for higher altitude.

Output Fusing

The converter is extensively protected against current, voltage and temperature extremes. However your output application circuit may need additional protection. In the extremely unlikely event of output circuit failure, excessive voltage could be applied to your circuit. Consider using an appropriate fuse in series with the output.

Output Current Limiting

Current limiting inception is defined as the point at which full power falls below the rated tolerance. See the Performance/Functional Specifications. Note particularly that the output current may briefly rise above its rated value in normal operation as long as the average output power is not exceeded. This enhances reliability and continued operation of your application. If the output current is too high, the converter will enter the short circuit condition.

Output Short Circuit Condition

When a converter is in current-limit mode, the output voltage will drop as the output current demand increases. If the output voltage drops too low (approximately 97% of nominal output voltage for most models), the PWM controller will shut down. Following a time-out period, the PWM will restart, causing the output voltage to begin rising to its appropriate value. If the short-circuit condition persists, another shutdown

cycle will initiate. This rapid on/off cycling is called "hiccup mode." The hiccup cycling reduces the average output current, thereby preventing excessive internal temperatures and/or component damage.

The "hiccup" system differs from older latching short circuit systems because you do not have to power down the converter to make it restart. The system will automatically restore operation as soon as the short circuit condition is removed.

Output Capacitive Load

These converters do not require external capacitance added to achieve rated specifications. Users should only consider adding capacitance to reduce switching noise and/or to handle spike current load steps. Install only enough capacitance to achieve noise objectives. Excess external capacitance may cause degraded transient response and possible oscillation or instability.

Remote Sense Input

Use the Sense inputs with caution. Sense is normally connected **at the load**. Sense inputs compensate for output voltage inaccuracy delivered at the load. This is done by correcting IR voltage drops along the output wiring and the current carrying capacity of PC board etc. This output drop (the difference between Sense and Vout when measured at the converter) should not exceed 0.5V. Consider using heavier wire if this drop is excessive. Sense inputs also improve the stability of the converter and load system by optimizing the control loop phase margin.

NOTE: The Sense input and power Vout lines are internally connected through low value resistors to their respective polarities so that the converter can operate without external connection to the Sense.

Nevertheless, if the Sense function is not used for remote regulation, the user should connect +Sense to +Vout and -Sense to -Vout at the converter pins.

The remote Sense lines carry very little current. They are also capacitively coupled to the output lines and therefore are in the feedback control loop to regulate and stabilize the output. As such, they are not low impedance inputs and must be treated with care in PC board layouts.

Sense lines on the PCB should run adjacent to DC signals, preferably Ground. In cables and discrete wiring, use twisted pair, shielded tubing or similar techniques.

Any long, distributed wiring and/or significant inductance introduced into the Sense control loop can adversely affect overall system stability. If in doubt,

test your applications by observing the converter's output transient response during step loads. There should not be any appreciable ringing or oscillation. You may also adjust the output trim slightly to compensate for voltage loss in any external filter elements. Do not exceed maximum power ratings.

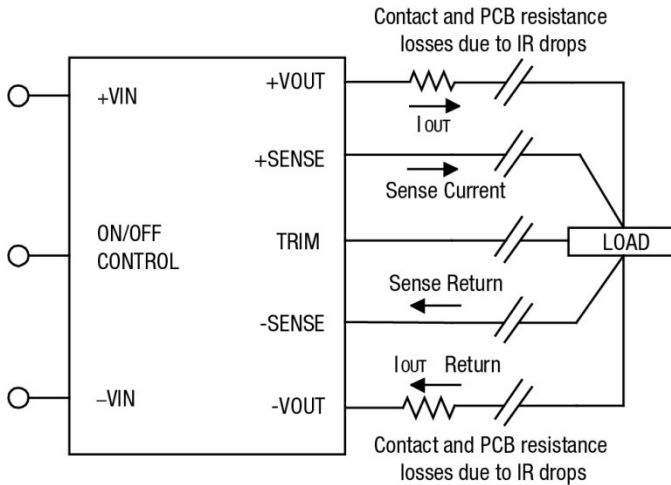


Figure 5. Remote Sense Circuit Configuration

Please observe Sense inputs tolerance to avoid improper operation:

$$[V_{out}(+) - V_{out}(-)] - [Sense(+) - Sense(-)] \leq 10\% \text{ of } V_{out}$$

Output overvoltage protection is monitored at the output voltage pin, not the Sense pin. Therefore excessive voltage differences between Vout and Sense together with trim adjustment of the output can cause the overvoltage protection circuit to activate and shut down the output.

Power derating of the converter is based on the combination of maximum output current and the highest output voltage. Therefore the designer must insure:

$$(V_{out} \text{ at pins}) \times (I_{out}) \leq (\text{Max. rated output power})$$

Trimming the Output Voltage

The Trim input to the converter allows the user to adjust the output voltage over the rated trim range (please refer to the Specifications). In the trim equations and circuit diagrams that follow, trim adjustments use either a trimpot or a single fixed resistor connected between the Trim input and either the +Sense or -Sense terminals. Trimming resistors should have a low temperature coefficient (± 100 ppm/deg.C or less) and be mounted close to the converter. Keep leads short. If the trim function is not used, leave the trim unconnected. With no trim, the

converter will exhibit its specified output voltage accuracy.

There are two CAUTIONs to observe for the Trim input:

CAUTION: To avoid unplanned power down cycles, do not exceed EITHER the maximum output voltage OR the maximum output power when setting the trim. Be particularly careful with a trimpot. If the output voltage is excessive, the OVP circuit may inadvertently shut down the converter. If the maximum power is exceeded, the converter may enter current limiting. If the power is exceeded for an extended period, the converter may overheat and encounter overtemperature shut down.

CAUTION: Be careful of external electrical noise. The Trim input is a sensitive input to the converter's feedback control loop. Excessive electrical noise may cause instability or oscillation. Keep external connections short to the Trim input. Use shielding if needed.

Trim Equations

Trim Down

Connect trim resistor between trim pin and -Sense

$$V_{TrimDn} (k\Omega) = \frac{V_o}{V_{nom} - V_o}$$

Trim Up

Connect trim resistor between trim pin and +Sense

$$V_{TrimUp} (k\Omega) = \frac{V_{nom} * (V_o - 1.23)}{1.23 * (V_o - V_{nom})} - 1$$

Where,

Do not exceed the specified trim range or maximum power ratings when adjusting trim. Use 1% precision resistors mounted close to the converter on short leads.

If sense is not installed, connect the trim resistor to the respective V_{out} pin.

Trim Circuits

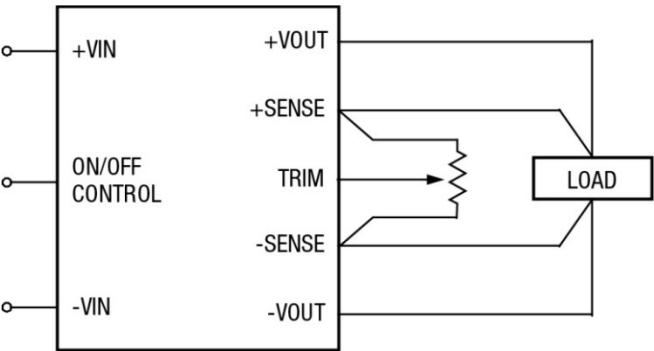


Figure 6. Trim Connections Using a Trimpot

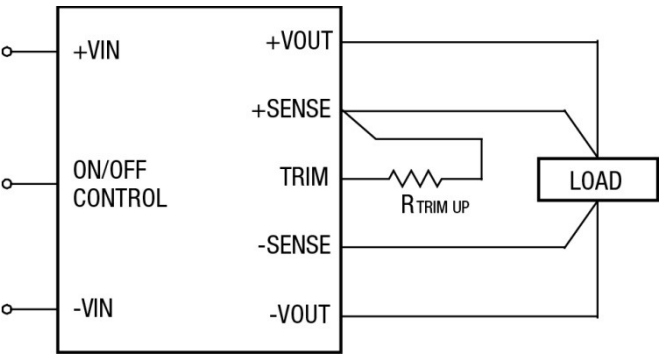


Figure 7. Trim Connections to Increase Output Voltage

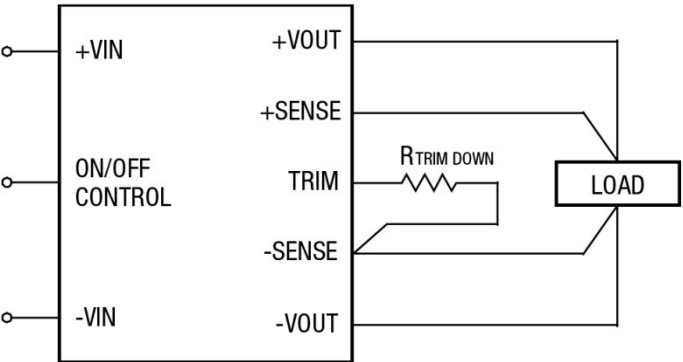


Figure 8. Trim Connections to Decrease Output Voltage

Soldering Guidelines

It is recommended to follow the specifications below when installing these converters. These specifications vary depending on the solder type. Exceeding these specifications may cause damage to the product. Your production environment may differ; therefore please thoroughly review these guidelines with your process engineers.

Wave Solder Operations for through-hole mounted products (THMT)			
For Sn/Ag/Cu based solders:		For Sn/Pb based solders:	
Maximum Preheat Temperature	115° C	Maximum Preheat Temperature	105° C
Maximum Pot Temperature	270° C	Maximum Pot Temperature	250° C
Maximum Solder Dwell Time	7 seconds	Maximum Solder Dwell Time	6 seconds

Emissions Performance

Products are measured for conducted emissions against the EN 50121-3-2 standard. Passive resistance loads are employed and the output is set to the maximum voltage. If you set up your own emissions testing, make sure the output load is rated at continuous power while doing the tests.

The recommended external input and output capacitors (if required) are included. Please refer to the fundamental switching frequency. All of this information is listed in the Product Specifications. An external discrete filter is installed and the circuit diagram is shown below.

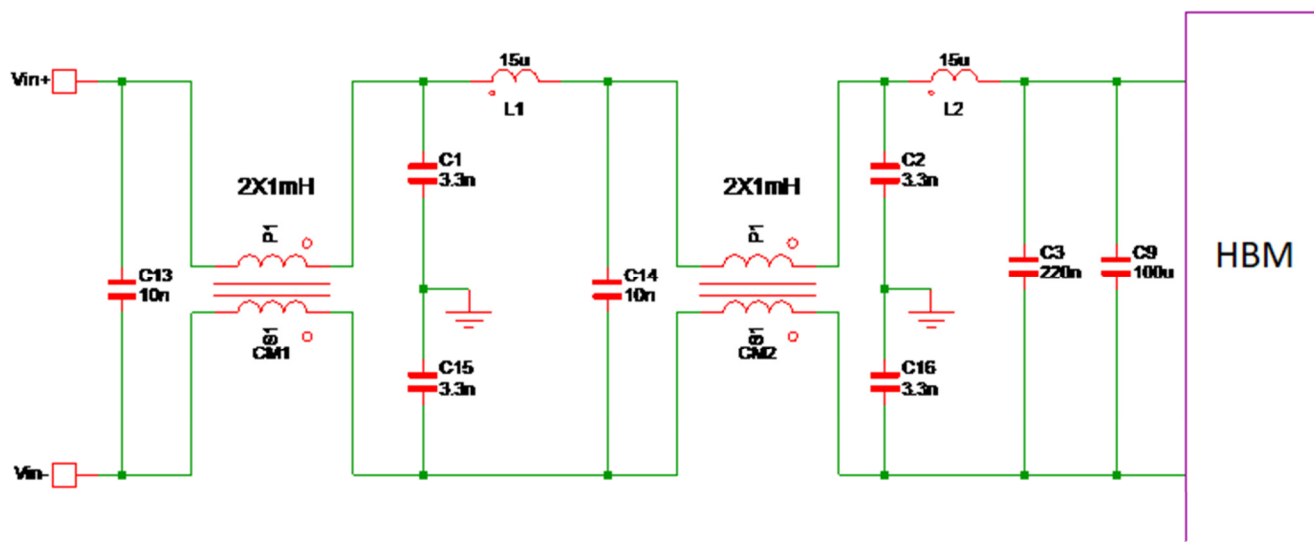


Figure 9. Conducted Emissions Test Circuit

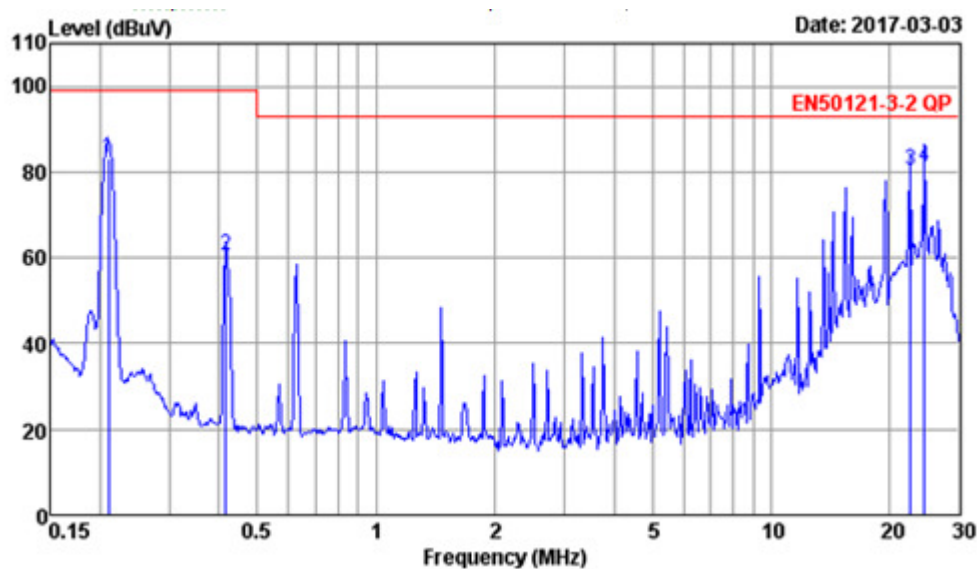
1] Conducted Emissions Parts List

Reference	Description	Part Number	Vendor
C13/C14	10nF (Class X1/Y2)	DE2F3KY103MA3BM02F	Murata
L1/L2	15uH/7.5A	7443551181	Wurth Electronics
C1/C2/C15/C16	3.3nF (Class X1/Y1)	DE1E3KX332MA4BP01F	Murata
CM1/CM2	1mH	C20200-08	ITG
C3	0.22uF/250V	GRM32DR72E224KW01L	Murata
C9	100uF/250V		Rubycon

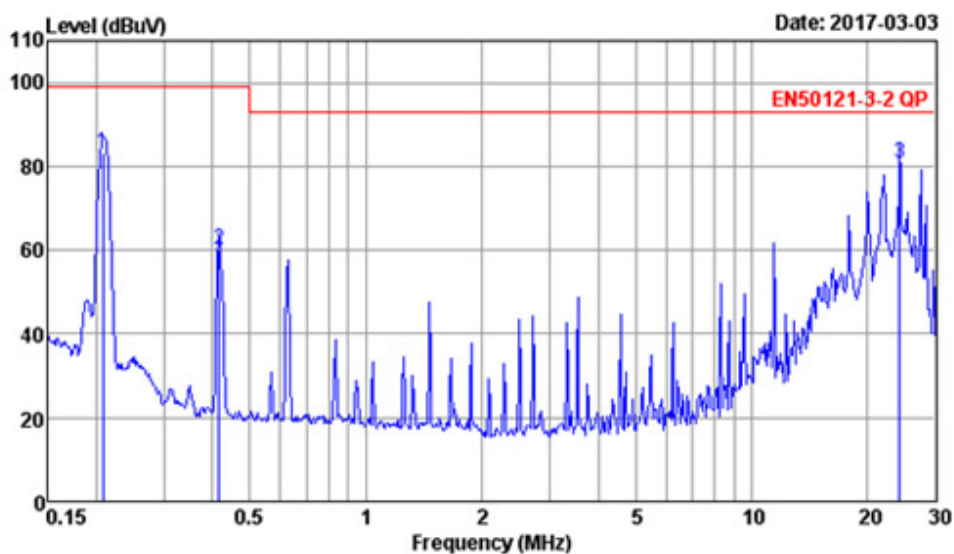
[2] Conducted Emissions Test Equipment Used

- Hewlett Packard HP8594L Spectrum Analyzer – S/N 3827A00153
- 2Line V-networks LS1-15V 50Ω/50uH Line Impedance Stabilization Network

[3] Conducted Emissions Test Results



Graph1. Conducted Emissions Performance.
Positive Line, EN50121-3-2, full load.



Graph 2. Conducted Emissions Performance.
Negative Line, EN50121-3-2, full load.